



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Attorney Docket No. 040679/0439

Applicant: Haruhiko MURATA et al.  
Title: IMPROVEMENT IN OR RELATING TO CIRCUIT BOARD  
HAVING SOLDER BUMPS  
Serial No.: 08/825,400  
Filed: March 28, 1997  
Examiner: Norris, Jeremy C.  
Art Unit: 2827

TRANSMITTAL OF FORMAL DRAWINGS

Commissioner for Patents  
Washington, D.C. 20231

ATTENTION: DRAWING REVIEW BRANCH

Sir:

Transmitted herewith are the formal drawings (12 sheets, Figures 1A-15B) for the above-identified application. The Official Draftsperson is respectfully requested to approve these drawings for entry into the application.

Respectfully submitted,

February 12, 2003  
Date  
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